## Features

- EE Programmable 65,536 x 1-, 131,072 x 1-, 262,144 x 1-, 524,288 x 1-, 1,048,576 x 1-, 2,097,152 x 1-, and 4,194,304 x 1-bit Serial Memories Designed to Store Configuration Programs for Field Programmable Gate Arrays (FPGAs)
- Supports both 3.3V and 5.0V Operating Voltage Applications
- In-System Programmable (ISP) via Two-Wire Bus
- Simple Interface to SRAM FPGAs
- Compatible with Atmel AT6000, AT40K and AT94K Devices, Altera<sup>®</sup> FLEX<sup>®</sup>, APEX<sup>™</sup> Devices, ORCA<sup>®</sup>, Xilinx<sup>®</sup> XC3000, XC4000, XC5200, Spartan<sup>®</sup>, Virtex<sup>™</sup> FPGAs
- Cascadable Read-back to Support Additional Configurations or Higher-density Arrays
- Very Low-power CMOS EEPROM Process
- Programmable Reset Polarity
- Available in 6 mm x 6 mm x 1 mm 8-lead LAP (Pin-compatible with 8-lead SOIC/VOIC Packages), 8-lead PDIP, 8-lead SOIC, 20-lead PLCC, 20-lead SOIC, 44-lead PLCC and 44-lead TQFP Packages
- Emulation of Atmel's AT24CXXX Serial EEPROMs
- Low-power Standby Mode
- High-reliability
  - Endurance: 100,000 Write Cycles
  - Data Retention: 90 Years for Industrial Parts (at 85°C) and 190 Years for Commercial Parts (at 70°C)
- Green (Pb/Halide-free/RoHS Compliant) Package Options Available

# 1. Description

The AT17LV series FPGA Configuration EEPROMs (Configurators) provide an easyto-use, cost-effective configuration memory for Field Programmable Gate Arrays. The AT17LV series device is packaged in the 8-lead LAP, 8-lead PDIP, 8-lead SOIC, 20lead PLCC, 20-lead SOIC, 44-lead PLCC and 44-lead TQFP, see Table 1-1. The AT17LV series Configurators uses a simple serial-access procedure to configure one or more FPGA devices. The user can select the polarity of the reset function by programming four EEPROM bytes. These devices also support a write-protection mechanism within its programming mode.

The AT17LV series configurators can be programmed with industry-standard programmers, Atmel's ATDH2200E Programming Kit or Atmel's ATDH2225 ISP Cable.



FPGA Configuration EEPROM Memory

AT17LV65 AT17LV128 AT17LV256 AT17LV512 AT17LV010 AT17LV002 AT17LV040

3.3V and 5V System Support





	AT17LV65/	AT171\//510/		
Package	AT17LV128/ AT17LV256	AT17LV512/ AT17LV010	AT17LV002	AT17LV040
8-lead LAP	Yes	Yes	Yes	(3)
8-lead PDIP	Yes	Yes	_	-
8-lead SOIC	Yes	Use 8-lead LAP <sup>(1)</sup>	Use 8-lead LAP <sup>(1)</sup>	(3)
20-lead PLCC	Yes	Yes	Yes	_
20-lead SOIC	Yes <sup>(2)</sup>	Yes <sup>(2)</sup>	Yes <sup>(2)</sup>	_
44-lead PLCC	_	-	Yes	Yes
44-lead TQFP	_	_	Yes	Yes

1. The 8-lead LAP package has the same footprint as the 8-lead SOIC. Since an 8-lead SOIC Notes: package is not available for the AT17LV512/010/002 devices, it is possible to use an 8-lead LAP package instead.

- 2. The pinout for the AT17LV65/128/256 devices is not pin-for-pin compatible with the AT17LV512/010/002 devices.
- 3. Refer to the AT17Fxxx datasheet, available on the Atmel web site.

#### **Pin Configuration** 2.

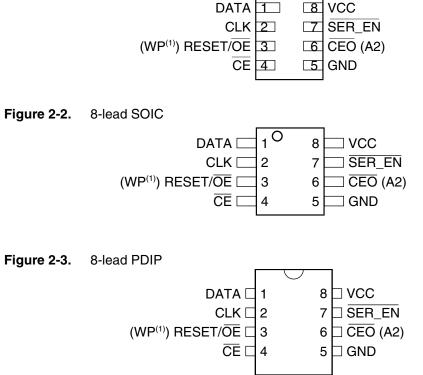
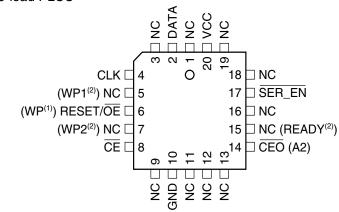


Figure 2-1. 8-lead LAP

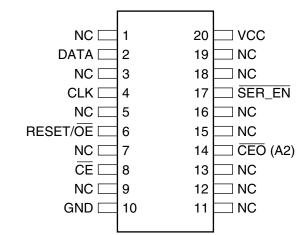
# AT17LV65/128/256/512/010/002/040

Figure 2-4. 20-lead PLCC



- Notes: 1. This pin is only available on AT17LV65/128/256 devices.
  - 2. This pin is only available on AT17LV512/010/002 devices.
  - 3. The  $\overline{CEO}$  feature is not available on the AT17LV65 device.

Figure 2-5. 20-lead SOIC<sup>(1)</sup>

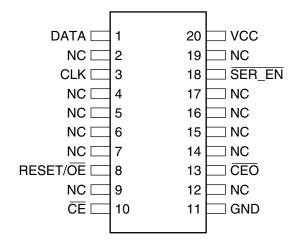


Note: 1. This pinout only applies to AT17LV65/128/256 devices.



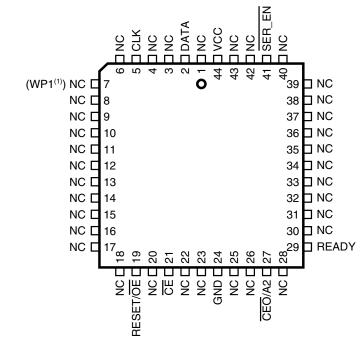


Figure 2-6. 20-lead SOIC<sup>(1)</sup>



- Notes: 1. This pinout only applies to AT17LV512/010/002 devices.
  - 2. The  $\overline{\text{CEO}}$  feature is not available on the AT17LV65 device.

Figure 2-7. 44 PLCC



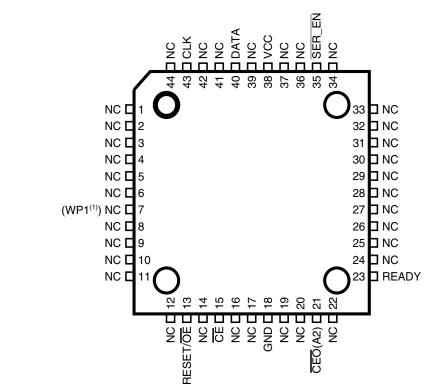
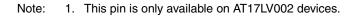
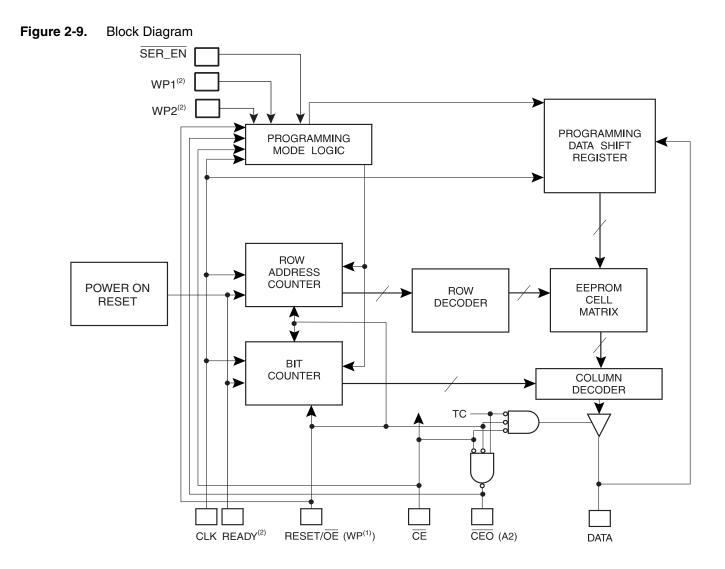


Figure 2-8. 44 TQFP









- Notes: 1. This pin is only available on AT17LV65/128/256 devices.
  - 2. This pin is only available on AT17LV512/010/002 devices.
  - 3. The  $\overline{\text{CEO}}$  feature is not available on the AT17LV65 device.

## 3. Device Description

The control signals for the configuration EEPROM ( $\overline{CE}$ , RESET/ $\overline{OE}$  and CCLK) interface directly with the FPGA device control signals. All FPGA devices can control the entire configuration process and retrieve data from the configuration EEPROM without requiring an external intelligent controller.

The configuration EEPROM RESET/ $\overline{OE}$  and  $\overline{CE}$  pins control the tri-state buffer on the DATA output pin and enable the address counter. When RESET/ $\overline{OE}$  is driven High, the configuration EEPROM resets its address counter and tri-states its DATA pin. The  $\overline{CE}$  pin also controls the output of the AT17LV series configurator. If  $\overline{CE}$  is held High after the RESET/ $\overline{OE}$  reset pulse, the counter is disabled and the DATA output pin is tri-stated. When  $\overline{OE}$  is subsequently driven Low, the counter and the DATA output pin are enabled. When RESET/ $\overline{OE}$  is driven High again, the address counter is reset and the DATA output pin is tri-stated, regardless of the state of  $\overline{CE}$ .

When the configurator has driven out all of its data and  $\overline{CEO}$  is driven Low, the device tri-states the DATA pin to avoid contention with other configurators. Upon power-up, the address counter is automatically reset.

This is the default setting for the device. Since almost all FPGAs use RESET Low and OE High, this document will describe RESET/OE.

		AT17LV65/ AT17LV128/ AT17LV256		AT17LV512/ AT17LV010			ļ	AT17LV040						
Name	I/O	8 DIP/ LAP/ SOIC	20 PLCC	20 SOIC	8 DIP/ LAP	20 PLCC	20 SOIC	8 DIP/ LAP/ SOIC	20 PLCC	20 SOIC	44 PLCC	44 TQFP	44 PLCC	44 TQFP
DATA	I/O	1	2	2	1	2	1	1	2	1	2	40	2	40
CLK	I	2	4	4	2	4	3	2	4	3	5	43	5	43
WP1	Ι	_	_	_	-	5	_	_	5	_	_	_	_	-
RESET/O E	I	3	6	6	3	6	8	3	6	8	19	13	19	13
WP2	Ι				-	7	-	-	7	-	-	-	-	-
CE	I	4	8	8	4	8	10	4	8	10	21	15	21	15
GND		5	10	10	5	10	11	5	10	11	24	18	24	18
CEO	0	_					13	-		13				
A2	I	6	14	14	6	14	-	6	14	Ι	27	21	27	21
READY	0	-	-	I	-	15	-	-	15	I	29	23	29	23
SER_EN	I	7	17	17	7	17	18	7	17	18	41	35	41	35
V <sub>cc</sub>		8	20	20	8	20	20	8	20	20	44	38	44	38

## 4. Pin Description

Note: 1. The  $\overline{CEO}$  feature is not available on the AT17LV65 device.





4.1	DATA	Three-state DATA output for configuration. Open-collector bi-directional pin for programming.
4.2	CLK	Clock input. Used to increment the internal address and bit counter for reading and programming.
4.3	WP1	WRITE PROTECT (1). Used to protect portions of memory during programming. Disabled by default due to internal pull-down resistor. This input pin is not used during FPGA loading operations. This pin is only available on AT17LV512/010/002 devices.
4.4	RESET/OE	Output Enable (active High) and RESET (active Low) when $\overline{\text{SER}_{EN}}$ is High. A Low level on $\overline{\text{RESET}/\text{OE}}$ resets both the address and bit counters. A High level (with $\overline{\text{CE}}$ Low) enables the data output driver. The logic polarity of this input is programmable as either RESET/ $\overline{\text{OE}}$ or $\overline{\text{RESET}}/\overline{\text{OE}}$ . For most applications, RESET should be programmed active Low. This document describes the pin as $\overline{\text{RESET}}/\overline{\text{OE}}$ .
4.5	WP	Write protect (WP) input (when $\overline{CE}$ is Low) during programming only ( $\overline{SER}_{EN}$ Low). When WP is Low, the entire memory can be written. When WP is enabled (High), the lowest block of the memory cannot be written. This pin is only available on AT17LV65/128/256 devices.
4.6	WP2	WRITE PROTECT (2). Used to protect portions of memory during programming. Disabled by default due to internal pull-down resistor. This input pin is not used during FPGA loading operations. This pin is only available on AT17LV512/010 devices.
4.7	CE	Chip Enable input (active Low). A Low level (with OE High) allows CLK to increment the address counter and enables the data output driver. A High level on $\overline{CE}$ disables both the address and bit counters and forces the device into a low-power standby mode. Note that this pin will <i>not</i> enable/disable the device in the Two-Wire Serial Programming mode (SER_EN Low).
4.8	GND	Ground pin. A 0.2 $\mu F$ decoupling capacitor between $V_{CC}$ and GND is recommended.
4.9	CEO	Chip Enable Output (active Low). This output goes Low when the address counter has reached its maximum value. In a daisy chain of AT17LV series devices, the $\overline{CEO}$ pin of one device must be connected to the $\overline{CE}$ input of the next device in the chain. It will stay Low as long as $\overline{CE}$ is Low and OE is High. It will then follow CE until OE goes Low; thereafter, $\overline{CEO}$ will stay High until the entire EEPROM is read again. This $\overline{CEO}$ feature is not available on the AT17LV65 device.

4.10	A2	
		Device selection input, A2. This is used to enable (or select) the device during programming (i.e., when SER_EN is Low). A2 has an internal pull-down resistor.
4.11	READY	
		Open collector reset state indicator. Driven Low during power-up reset, released when power-up is complete. It is recommended to use a 4.7 k $\Omega$ pull-up resistor when this pin is used.
4.12	SER_EN	
	_	Serial enable must be held High during FPGA loading operations. Bringing $\overline{SER}_{EN}$ Low enables the Two-Wire Serial Programming Mode. For non-ISP applications, $\overline{SER}_{EN}$ should be tied to $V_{CC}$ .
4.13	V <sub>cc</sub>	
_		3.3V ( $\pm$ 10%) and 5.0V ( $\pm$ 5% Commercial, $\pm$ 10% Industrial) power supply pin.

## 5. FPGA Master Serial Mode Summary

The I/O and logic functions of any SRAM-based FPGA are established by a configuration program. The program is loaded either automatically upon power-up, or on command, depending on the state of the FPGA mode pins. In Master mode, the FPGA automatically loads the configuration program from an external memory. The AT17LV Serial Configuration EEPROM has been designed for compatibility with the Master Serial mode.

This document discusses the Atmel AT40K, AT40KAL and AT94KAL applications as well as Xilinx applications.

## 6. Control of Configuration

Most connections between the FPGA device and the AT17LV Serial EEPROM are simple and self-explanatory.

- The DATA output of the AT17LV series configurator drives DIN of the FPGA devices.
- The master FPGA CCLK output drives the CLK input of the AT17LV series configurator.
- The CEO output of any AT17LV series configurator drives the CE input of the next configurator in a cascaded chain of EEPROMs.
- $\overline{\text{SER}\_\text{EN}}$  must be connected to  $\text{V}_{\text{CC}}$  (except during ISP).
- The READY<sup>(1)</sup> pin is available as an open-collector indicator of the device's reset status; it is driven Low while the device is in its power-on reset cycle and released (tri-stated) when the cycle is complete.
- Note: 1. This pin is not available for the AT17LV65/128/256 devices.





## 7. Cascading Serial Configuration EEPROMs

For multiple FPGAs configured as a daisy-chain, or for FPGAs requiring larger configuration memories, cascaded configurators provide additional memory.

After the last bit from the first configurator is read, the clock signal to the configurator asserts its  $\overline{CEO}$  output Low and disables its DATA line driver. The second configurator recognizes the Low level on its  $\overline{CE}$  input and enables its DATA output.

After configuration is complete, the address counters of all cascaded configurators are reset if the  $\overline{\text{RESET}}/\text{OE}$  on each configurator is driven to its active (Low) level.

If the address counters are not to be reset upon completion, then the RESET/OE input can be tied to its inactive (High) level.

The AT17LV65 devices do not have the  $\overline{CEO}$  feature to perform cascaded configurations.

### 8. AT17LV Series Reset Polarity

The AT17LV series configurator allows the user to program the reset polarity as either RESET/ $\overline{OE}$  or  $\overline{RESET}/OE$ . This feature is supported by industry-standard programmer algorithms.

### 9. Programming Mode

The programming mode is entered by bringing  $\overline{SER}_{EN}$  Low. In this mode the chip can be programmed by the Two-Wire serial bus. The programming is done at V<sub>CC</sub> supply only. Programming super voltages are generated inside the chip.

### 10. Standby Mode

The AT17LV series configurators enter a low-power standby mode whenever  $\overline{CE}$  is asserted High. In this mode, the AT17LV65/128/256 configurator consumes less than 50 µA of current at 3.3V (100 µA for the AT17LV512/010 and 200 µA for the AT17LV002/040). The output remains in a high-impedance state regardless of the state of the  $\overline{OE}$  input.

## 11. Absolute Maximum Ratings\*

Operating Temperature40°C to +85°C
Storage Temperature65 °C to +150 °C
Voltage on Any Pin with Respect to Ground0.1V to $V_{CC}$ +0.5V
Supply Voltage (V <sub>CC</sub> )0.5V to +7.0V
Maximum Soldering Temp. (10 sec. @ 1/16 in.)260°C
ESD (R <sub>ZAP</sub> = 1.5K, C <sub>ZAP</sub> = 100 pF)

\*NOTICE: Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those listed under operating conditions is not implied. Exposure to Absolute Maximum Rating conditions for extended periods of time may affect device reliability.

## 12. Operating Conditions

	Commercial Supply voltage relative to GND -0°C to +70°C		3.	3V	Ę		
Symbol	Description		Min	Max	Min	Max	Units
	Commercial		3.0	3.6	4.75	5.25	v
V <sub>cc</sub>	Industrial	Supply voltage relative to GND -40°C to +85°C	3.0	3.6	4.5	5.5	V





# **13. DC Characteristics**

 $V_{CC}=3.3V\pm10\%$ 

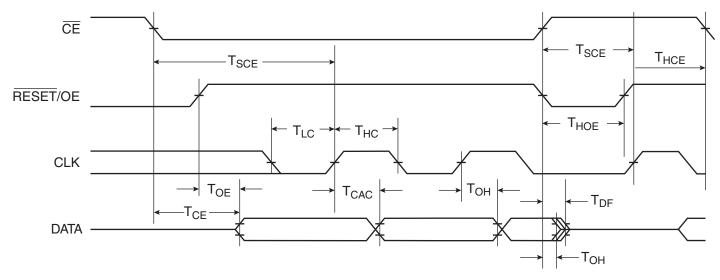
				AT17LV65/ AT17LV128/ AT17LV256		AT17LV512/ AT17LV010		AT17LV002/ AT17LV040	
Symbol	Description		Min	Мах	Min	Max	Min	Мах	Units
V <sub>IH</sub>	High-level Input Voltage		2.0	V <sub>cc</sub>	2.0	V <sub>cc</sub>	2.0	V <sub>cc</sub>	V
V <sub>IL</sub>	Low-level Input Voltage		0	0.8	0	0.8	0	0.8	V
V <sub>OH</sub>	High-level Output Voltage (I <sub>OH</sub> = -2.5 mA)	Commercial	2.4		2.4		2.4		V
V <sub>OL</sub>	Low-level Output Voltage (I <sub>OL</sub> = +3 mA)			0.4		0.4		0.4	V
V <sub>OH</sub>	High-level Output Voltage (I <sub>OH</sub> = -2 mA)	la destatel	2.4		2.4		2.4		V
V <sub>OL</sub>	Low-level Output Voltage (I <sub>OL</sub> = +3 mA)	Industrial		0.4		0.4		0.4	V
I <sub>CCA</sub>	Supply Current, Active Mode			5		5		5	mA
IL.	Input or Output Leakage Current ( $V_{IN} = V_{CC}$	or GND)	-10	10	-10	10	-10	10	μA
		Commercial		50		100		150	μA
I <sub>CCS</sub>	Supply Current, Standby Mode	Industrial		100		100		150	μA

## 14. DC Characteristics

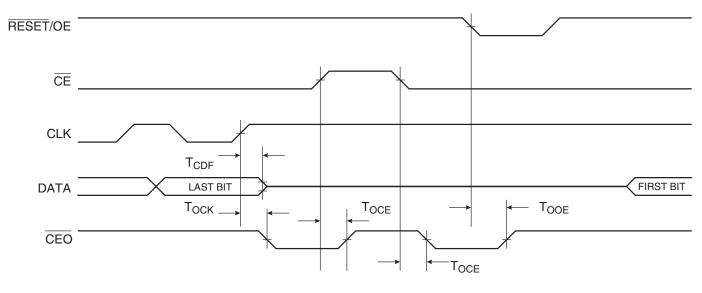
 $V_{CC}$  = 5V  $\pm$  5% Commercial;  $V_{CC}$  = 5V  $\pm$  10% Industrial

				AT17LV65/ AT17LV128/ AT17LV256		AT17LV512/ AT17LV010		AT17LV002/ AT17LV040		
Symbol	Description	Min	Мах	Min	Мах	Min	Мах	Units		
V <sub>IH</sub>	High-level Input Voltage		2.0	V <sub>cc</sub>	2.0	V <sub>cc</sub>	2.0	V <sub>cc</sub>	V	
V <sub>IL</sub>	Low-level Input Voltage		0	0.8	0	0.8	0	0.8	V	
V <sub>OH</sub>	High-level Output Voltage (I <sub>OH</sub> = -2.5 mA)	Commercial	3.7		3.86		3.86		V	
V <sub>OL</sub>	Low-level Output Voltage (I <sub>OL</sub> = +3 mA)			0.32		0.32		0.32	V	
V <sub>OH</sub>	High-level Output Voltage (I <sub>OH</sub> = -2 mA)		3.6		3.76		3.76		V	
V <sub>OL</sub>	Low-level Output Voltage (I <sub>OL</sub> = +3 mA)	Industrial		0.37		0.37		0.37	V	
I <sub>CCA</sub>	Supply Current, Active Mode			10		10		10	mA	
IL	Input or Output Leakage Current ( $V_{IN} = V_{CC}$	or GND)	-10	10	-10	10	-10	10	μA	
		Commercial		75		200		350	μA	
I <sub>CCS</sub>	Supply Current, Standby Mode Industrial			150		200		350	μA	

## 15. AC Waveforms



## 16. AC Waveforms when Cascading







# **17. AC Characteristics**

 $V_{CC} = 3.3V \pm 10\%$ 

			AT							
		Commercial		Industrial		Commercial		Industrial		
Symbol	Description	Min	Max	Min	Max	Min	Max	Min	Max	Units
T <sub>OE</sub> <sup>(1)</sup>	OE to Data Delay		50		55		50		55	ns
T <sub>CE</sub> <sup>(1)</sup>	CE to Data Delay		60		60		55		60	ns
T <sub>CAC</sub> <sup>(1)</sup>	CLK to Data Delay		75		80		55		60	ns
Т <sub>ОН</sub>	Data Hold from $\overline{CE}$ , OE, or CLK	0		0		0		0		ns
T <sub>DF</sub> <sup>(2)</sup>	CE or OE to Data Float Delay		55		55		50		50	ns
T <sub>LC</sub>	CLK Low Time	25		25		25		25		ns
T <sub>HC</sub>	CLK High Time	25		25		25		25		ns
T <sub>SCE</sub>	CE Setup Time to CLK (to guarantee proper counting)	35		60		30		35		ns
T <sub>HCE</sub>	CE Hold Time from CLK (to guarantee proper counting)	0		0		0		0		ns
T <sub>HOE</sub>	OE High Time (guarantees counter is reset)	25		25		25		25		ns
F <sub>MAX</sub>	Maximum Clock Frequency		10		10		15		10	MHz

Notes: 1. AC test lead = 50 pF.

2. Float delays are measured with 5 pF AC loads. Transition is measured  $\pm$  200 mV from steady-state active levels.

# **18. AC Characteristics when Cascading**

 $V_{CC} = 3.3V \pm 10\%$ 

		AT17LV65/128/256				AT17LV512/010/002/040				
		Commercial		Industrial		Commercial		Industrial		
Symbol	Description	Min	Max	Min	Max	Min	Max	Min	Max	Units
T <sub>CDF</sub> <sup>(2)</sup>	CLK to Data Float Delay		60		60		50		50	ns
T <sub>OCK</sub> <sup>(1)</sup>	CLK to CEO Delay		55		60		50		55	ns
T <sub>OCE</sub> <sup>(1)</sup>	CE to CEO Delay		55		60		35		40	ns
T <sub>OOE</sub> <sup>(1)</sup>	RESET/OE to CEO Delay		40		45		35		35	ns
F <sub>MAX</sub>	Maximum Clock Frequency		8		8		12.5		10	MHz

Notes: 1. AC test lead = 50 pF.

2. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady-state active levels.

## **19. AC Characteristics**

 $V_{CC} = 5V \pm 5\%$  Commercial;  $V_{CC} = 5V \pm 10\%$  Industrial

			AT17LV6	5/128/250	6	AT					
		Commercial		Industrial		Commercial		Industrial			
Symbol	Description	Min	Max	Min	Max	Min	Max	Min	Max	Units	
T <sub>OE</sub> <sup>(1)</sup>	OE to Data Delay		30		35		30		35	ns	
T <sub>CE</sub> <sup>(1)</sup>	CE to Data Delay		45		45		45		45	ns	
T <sub>CAC</sub> <sup>(1)</sup>	CLK to Data Delay		50		55		50		50	ns	
Т <sub>ОН</sub>	Data Hold from $\overline{CE}$ , OE, or CLK	0		0		0		0		ns	
T <sub>DF</sub> <sup>(2)</sup>	CE or OE to Data Float Delay		50		50		50		50	ns	
T <sub>LC</sub>	CLK Low Time	20		20		20		20		ns	
T <sub>HC</sub>	CLK High Time	20		20		20		20		ns	
T <sub>SCE</sub>	CE Setup Time to CLK (to guarantee proper counting)	35		40		20		25		ns	
T <sub>HCE</sub>	CE Hold Time from CLK (to guarantee proper counting)	0		0		0		0		ns	
T <sub>HOE</sub>	OE High Time (guarantees counter is reset)	20		20		20		20		ns	
F <sub>MAX</sub>	Maximum Clock Frequency		12.5		12.5		15		15	MHz	

Notes: 1. AC test lead = 50 pF.

2. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady-state active levels.

# 20. AC Characteristics when Cascading

 $V_{CC}$  = 5V  $\pm$  5% Commercial;  $V_{CC}$  = 5V  $\pm$  10% Industrial

		AT17LV65		5/128/256	5	AT17LV512/		/010/002/040		
		Comn	Commercial		Industrial		Commercial		Industrial	
Symbol	Description	Min	Max	Min	Max	Min	Мах	Min	Max	Units
T <sub>CDF</sub> <sup>(2)</sup>	CLK to Data Float Delay		50		50		50		50	ns
T <sub>OCK</sub> <sup>(1)</sup>	CLK to CEO Delay		35		40		35		40	ns
T <sub>OCE</sub> <sup>(1)</sup>	CE to CEO Delay		35		35		35		35	ns
T <sub>OOE</sub> <sup>(1)</sup>	RESET/OE to CEO Delay		30		35		30		30	ns
F <sub>MAX</sub>	Maximum Clock Frequency		10		10		12.5		12.5	MHz

Notes: 1. AC test lead = 50 pF.

2. Float delays are measured with 5 pF AC loads. Transition is measured ± 200 mV from steady-state active levels.





## 21. Thermal Resistance Coefficients<sup>(1)</sup>

Packag	је Туре		AT17LV65/ AT17LV128/ AT17LV256	AT17LV512/ AT17LV010	AT17LV002	AT17LV040
2011		$\theta_{JC}$ [°C/W]	45	45	45	-
8CN 4	Leadless Array Package (LAP)	θ <sub>JA</sub> [°C/W] <sup>(2)</sup>	115.71	135.71	159.60	_
	Plastia Dual Inlina Paakaga	$\theta_{JC}$ [°C/W]	37	37	_	-
8P3 (PDIP)	Plastic Dual Inline Package (PDIP)	θ <sub>JA</sub> [°C/W] <sup>(2)</sup>	107	107	_	_
	Plaatia Cull Wing Small Outling	$\theta_{JC}$ [°C/W]	45	_	_	-
8S1 (SOIC)	Plastic Gull Wing Small Outline (SOIC)	θ <sub>JA</sub> [°C/W] <sup>(2)</sup>	150	_	_	_
	Plastia Looded Chip Carrier	$\theta_{JC}$ [°C/W]	35	35	35	-
20J	Plastic Leaded Chip Carrier (PLCC)	θ <sub>JA</sub> [°C/W] <sup>(2)</sup>	90	90	90	_
	Plaatia Cull Wing Small Outling	$\theta_{JC}$ [°C/W]				-
20S2	Plastic Gull Wing Small Outline (SOIC)	θ <sub>JA</sub> [°C/W] <sup>(2)</sup>				_
	Thin Plantin Quad Elat	$\theta_{JC}$ [°C/W]	_		17	17
	Thin Plastic Quad Flat Package (TQFP)	θ <sub>JA</sub> [°C/W] <sup>(2)</sup>	_	_	62	62
	Plastic Looded Chip Carrier	$\theta_{JC}$ [°C/W]			15	15
44J	Plastic Leaded Chip Carrier (PLCC)	θ <sub>JA</sub> [°C/W] <sup>(2)</sup>	_	_	50	50

Notes: 1. For more information refer to the "Thermal Characteristics of Atmel's Packages", available on the Atmel web site.

2. Airflow = 0 ft/min.

## Figure 21-1. Ordering Code

AT17LV65A-10PC								
					<u> </u>		<	
Voltage	Size (B	Bits)	Special Pi	nouts	Pa	ckage	Temperature	
3.0V to 5.5V	65	= 65K	A = Al	tera	С	= 8CN4	C = Commercial	
	128	= 128K	Blank = Xi		Ρ	= 8P3	I = Industrial	
	256	= 256K	Other		Ν	= 8S1	U = Fully Green	
	512	= 512K			J	= 20J		
	010	= 1M			S	= 20S2		
	002	= 2M			ТС	) = 44A		
	040	= 4M			BJ	= 44J		

	Package Type				
8CN4	8-lead, 6 mm x 6 mm x 1 mm, Leadless Array Package (LAP) – Pin-compatible with 8-lead SOIC/VOID Packages				
8P3	8-lead, 0.300" Wide, Plastic Dual Inline Package (PDIP)				
8S1	8-lead, 0.150" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)				
20J	20-lead, Plastic J-leaded Chip Carrier (PLCC)				
20S2	20-lead, 0.300" Wide, Plastic Gull Wing Small Outline (JEDEC SOIC)				
44A	44-lead, Thin (1.0 mm) Plastic Quad Flat Package Carrier (TQFP)				
44J	44-lead, Plastic J-leaded Chip Carrier (PLCC)				





# <sup>18</sup> AT17LV65/128/256/512/010/002/040

	AT17LV65-10CC	8CN4	
	AT17LV65-10PC	8P3	Commercial
	AT17LV65-10NC	8S1	Commercial (0°C to 70°C)
	AT17LV65-10JC	20J	
64-Kbit <sup>(1)</sup>	AT17LV65-10SC	20S2	
04-KDIL /	AT17LV65-10CI	8CN4	
	AT17LV65-10PI	8P3	la du atrial
	AT17LV65-10NI	8S1	Industrial (-40°C to 85°C)
	AT17LV65-10JI	20J	(-40 0 10 00 0)
	AT17LV65-10SI	20S2	
	AT17LV128-10CC	8CN4	
	AT17LV128-10PC	8P3	
	AT17LV128-10NC	8S1	Commercial (0°C to 70°C)
	AT17LV128-10JC	20J	
	AT17LV128-10SC	20S2	
128-Kbit <sup>(1)</sup>	AT17LV128-10CI	8CN4	
	AT17LV128-10PI	8P3	
	AT17LV128-10NI	8S1	Industrial
	AT17LV128-10JI	20J	(-40°C to 85°C)
	AT17LV128-10SI	20S2	
	AT17LV256-10CC	8CN4	
	AT17LV256-10PC	8P3	
	AT17LV256-10NC	8S1	Commercial (0°C to 70°C)
	AT17LV256-10JC	20J	
	AT17LV256-10SC	20S2	
256-Kbit <sup>(1)</sup>	AT17LV256-10CI	8CN4	
	AT17LV256-10PI	8P3	
	AT17LV256-10NI	8S1	Industrial (-40°C to 85°C)
	AT17LV256-10JI	20J	(-40 C 10 85 C)
	AT17LV256-10SI	20S2	
	AT17LV512-10CC	8CN4	
	AT17LV512-10PC	8P3	Commercial
	AT17LV512-10JC	20J	(0°C to 70°C)
	AT17LV512-10SC	20S2	
512-Kbit <sup>(1)</sup>	AT17LV512-10CI	8CN4	
	AT17LV512-10PI	8P3	Industrial
	AT17LV512-10JI	20J	(-40°C to 85°C)
	AT17LV512-10SI	20S2	



Package

**Operation Range** 

# 22. Ordering Information

**Memory Size** 

## 22.1 Standard Package Options

**Ordering Code** 

Memory Size	Ordering Code	Package	Operation Range	
	AT17LV010-10CC	8CN4		
	AT17LV010-10PC	8P3	Commercial	
	AT17LV010-10JC	20J	(0°C to 70°C)	
1-Mbit <sup>(1)</sup>	AT17LV010-10SC	20S2		
	AT17LV010-10CI	8CN4		
	AT17LV010-10PI	8P3	Industrial	
	AT17LV010-10JI	20J	(-40°C to 85°C)	
	AT17LV010-10SI	20S2		
	AT17LV002-10CC	8CN4		
	AT17LV002-10JC	20J	Commercial (0°C to 70°C)	
	AT17LV002-10SC	20S2		
	AT17LV002-10TQC	44A		
2-Mbit <sup>(1)</sup>	AT17LV002-10BJC	44J		
	AT17LV002-10CI	8CN4		
	AT17LV002-10JI	20J		
	AT17LV002-10SI	20S2	Industrial (-40°C to 85°C)	
	AT17LV002-10TQI	44A	(-40 0 10 03 0)	
	AT17LV002-10BJI	44J		
	AT17LV040-10TQC	44A	Commercial	
4-Mbit <sup>(1)</sup>	AT17LV040-10BJC	44J	(0°C to 70°C)	
	AT17LV040-10TQI	44A	Industrial	
	AT17LV040-10BJI	44J	(-40°C to 85°C)	

### 22.1 Standard Package Options (Continued)

Notes: 1. For operating 5V operating voltage, please refer to the corresponding AC and DC Characteristics.

2. The last-time buy is April 11, 2006 for shaded parts.

3. For the -10CC and -10Cl packages, customers may migrate to AT17LVXXX-10CU.





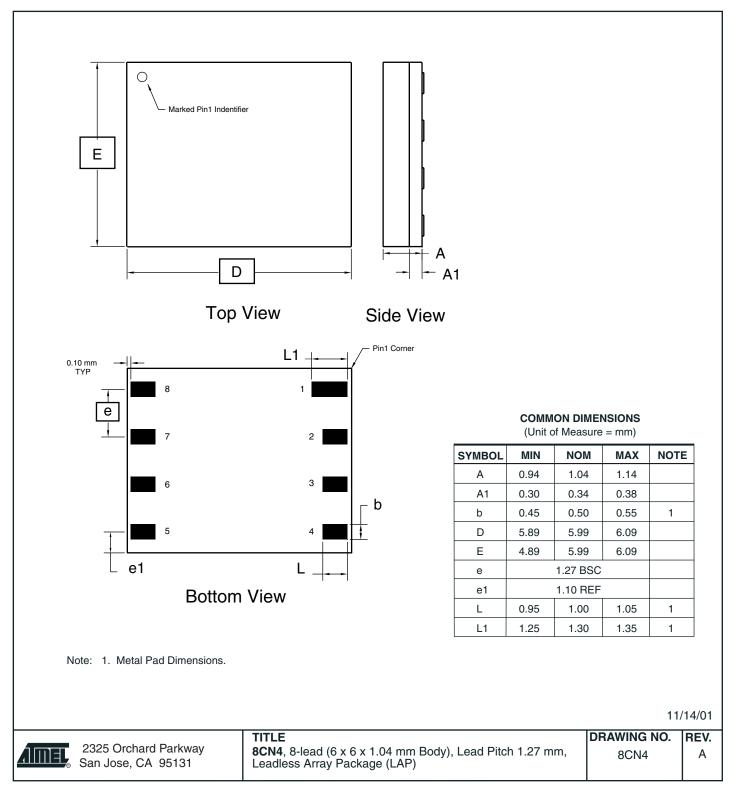
## 22.2 Green Package Options (Pb/Halide-free/RoHS Compliant)

Memory Size	Ordering Code	Package	Operation Range	
	AT17LV256-10CU	8CN4		
	AT17LV256-10JU	20J		
256-Kbit <sup>(1)</sup>	AT17LV256-10NU	8S1	Industrial (-40°C to 85°C)	
	AT17LV256-10PU	8P3	(-40 C 10 85 C)	
	AT17LV256-10SU	20S2		
512-Kbit <sup>(1)</sup>	AT17LV512-10CU	8CN4	Industrial	
512-KDI(**	AT17LV512-10JU	20J	(-40°C to 85°C)	
	AT17LV010-10CU	8CN4		
1-Mbit <sup>(1)</sup>	AT17LV010-10JU	20J	Industrial (-40°C to 85°C)	
	AT17LV010-10PU	8P3	(-40 C 10 85 C)	
	AT17LV002-10CU	8CN4		
2-Mbit <sup>(1)</sup>	AT17LV002-10JU	20J	Industrial	
	AT17LV002-10SU	20S2	(-40°C to 85°C)	
	AT17LV002-10TQU	44A		
4-Mbit <sup>(1)</sup>	AT17LV040-10TQU	44A	Industrial	
4-101011	ATT/2040-101Q0	44A	(-40°C to 85°C)	

Note: 1. For operating 5V operating voltage, please refer to the corresponding AC and DC Characteristics.

## 23. Packaging Information

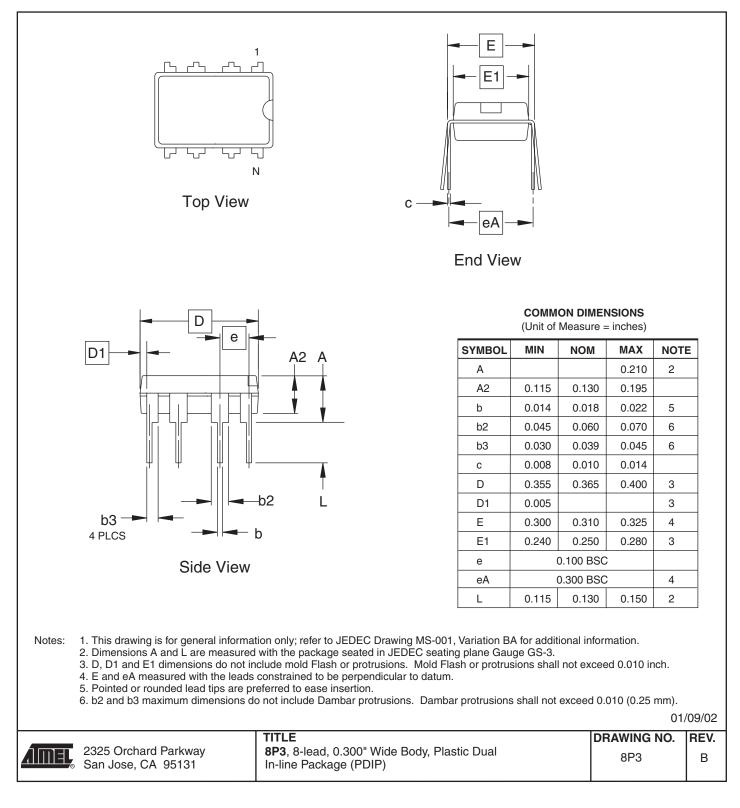
### 23.1 8CN4 - LAP



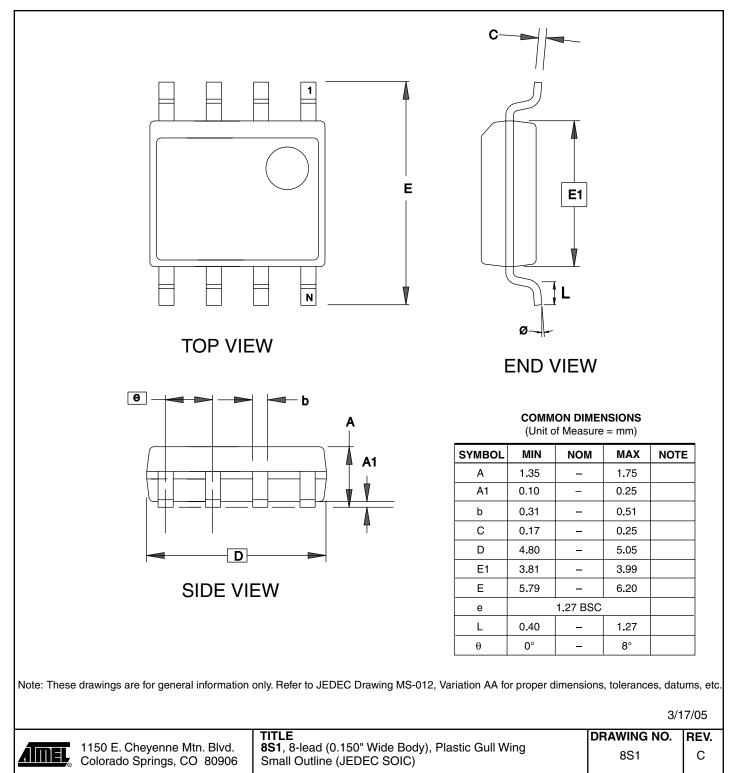




#### 23.2 8P3 - PDIP



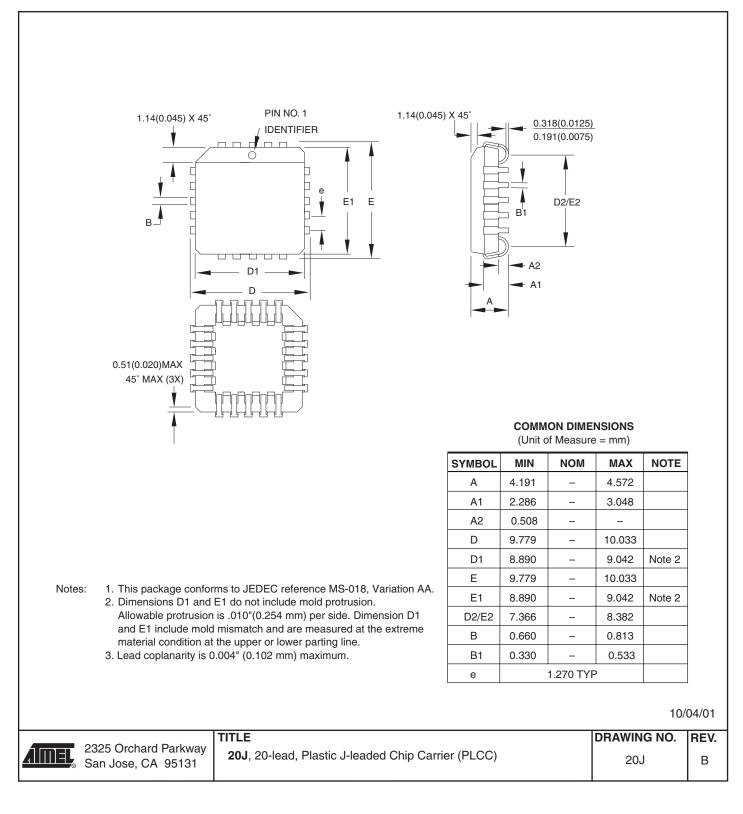
### 23.3 8S1 - SOIC





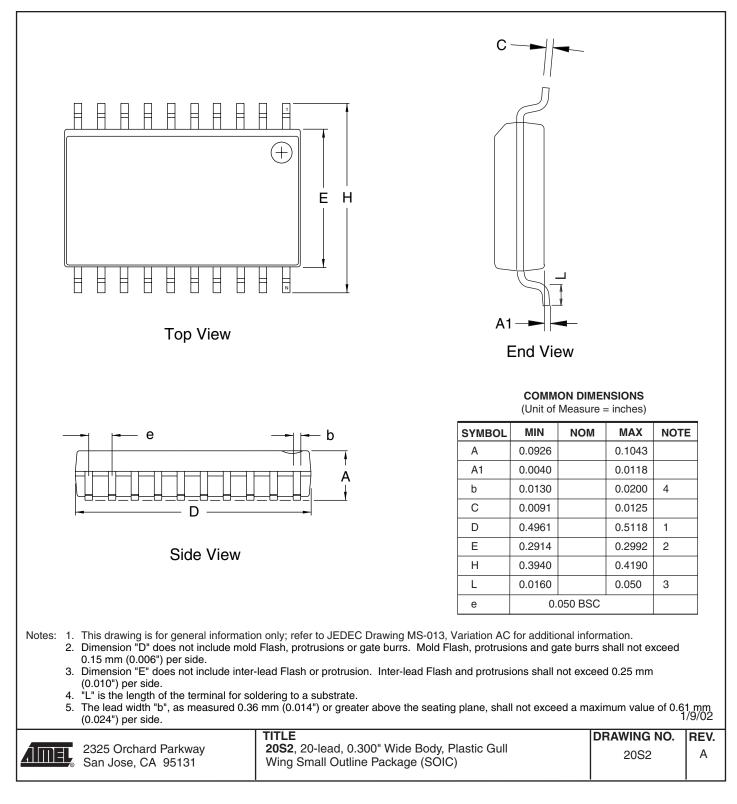


### 23.4 20J - PLCC



# <sup>24</sup> AT17LV65/128/256/512/010/002/040

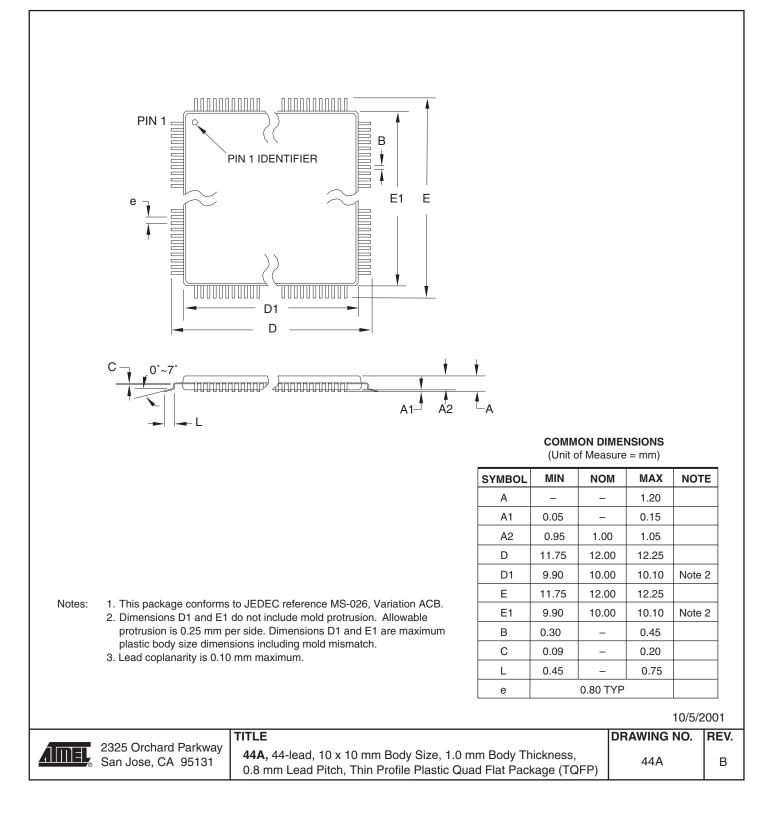
#### 23.5 20S2 - SOIC



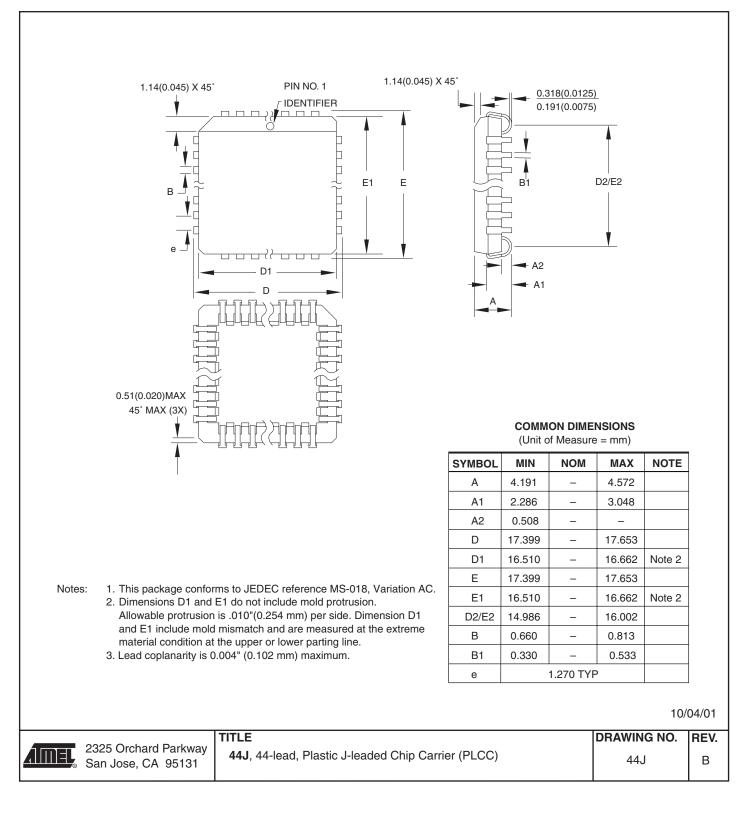




### 23.6 44A – TQFP



### 23.7 44J - PLCC







# 24. Revision History

Revision Level – Release Date	History
H – March 2006	Added last-time buy for AT17LVXXX-10CC and AT17LVXXX-10CI.



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